

# An Acoustic Beamforming Device For Personalized Audio Experiences

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# An Acoustic Beamforming Device

- Sends arrays of ultrasonic sound with audible audio signals modulated into them, which demodulate to audible sounds in the air.
- Creates very narrow beams of sound, that is controllable in both direction and magnitude.
- We were tasked with miniaturizing the existing prototype for more convenient transport and usage.
- As a team with a diverse set of skills, we also explored other possible improvement of the device and its capabilities.

# Beamforming & Demodulation Principles

- The beamforming device transmits amplitude modulated audio content through a parametric acoustic array (PAA) [1].
- The PAA is made up of 112 ultrasonic transducers, arranged in 8 columns. • Individual columns are interleaved, to minimize side lobe effects. • Phenomena called "medium and motion nonlinearities" in the air cause the
- ultrasonic carrier wave to demodulate [1].
- The result is a highly directional beam of sound.
- The PAA has lower off-axis response than a conventional speaker. • The acoustic beam can be steered by manipulating the phase of the signal
- being sent into each of the 8 columns in the PAA.
- Phase manipulation is performed in software.

# Prototype

- The prototype was developed by Juan Pampin and Michael McCrea.
- It used a rack-mounted DAC and amplifier board, as well as a bench power supply.
- The DAC required a thunderbolt connection to computer running the sound generation software.
- The setup was heavy and roughly 4 cubic feet in size, and the DAC was very expensive, making it inconvenient to transport.





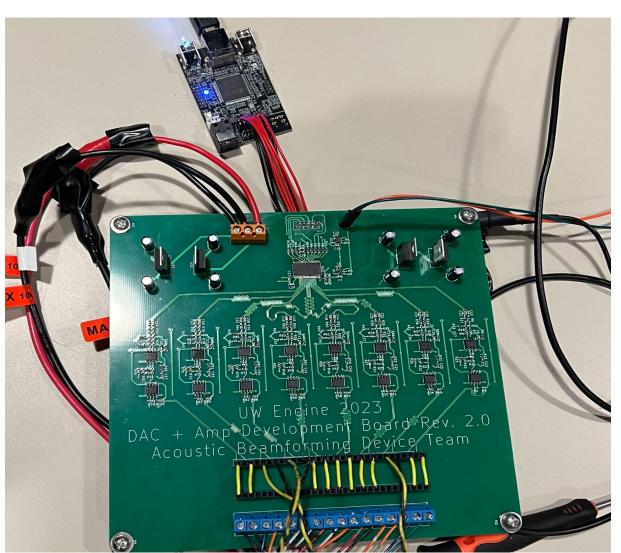
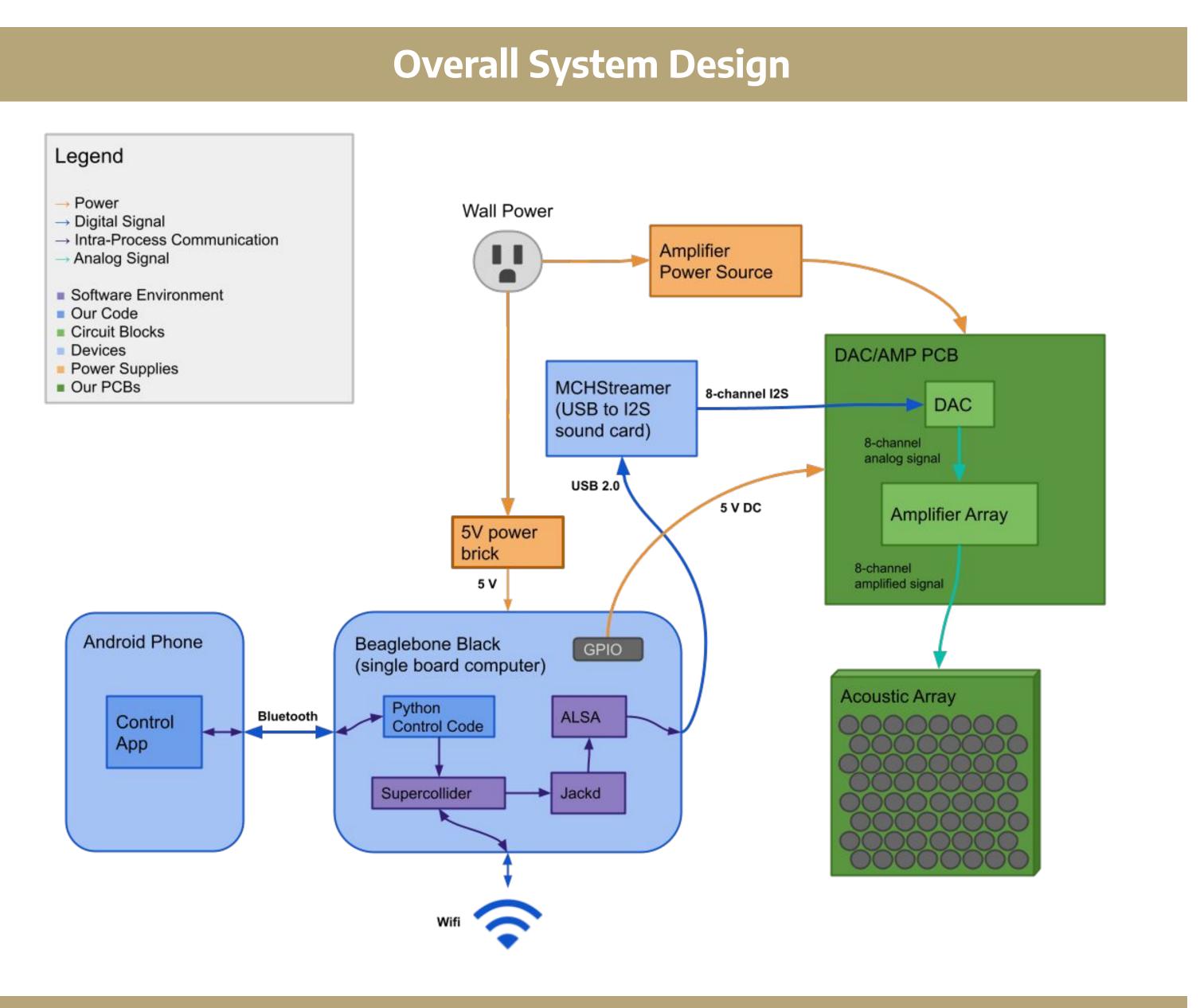


Fig 2. New DAC+Amp board

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# Hardware

### • **PAA**

• Ole Wolff Electronics Inc OWS-081528TA-6 Surface-mount speaker

### • DAC

- Texas Instruments PCM1690 Integrated Circuit
- Flexible Control Modes and Audio Interface, we're using 12S

### • AMP

- Custom 3-stage Class AB amplifier
- Butterworth LPF, First-Order Gain Stage, and a single-ended to differential converter.
- Power supplies
- Pre-built power supply module which will be mounted into the enclosure

### • Enclosure

• All hardware except the PAA will be mounted in a 3d printed box which is light and has a size of one eighth of the prototype rack.

**ADVISERS:** Juan Pampin, Eric Klavins **SPONSOR:** DXArts, University of Washington

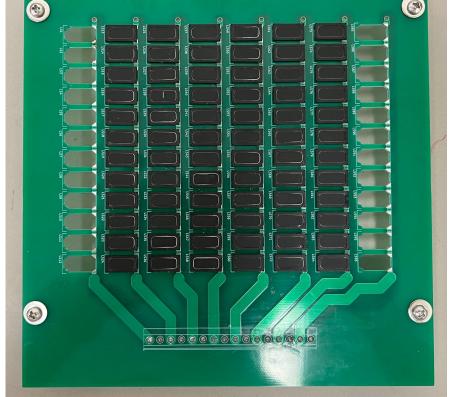


Fig 3. New PAA board with six columns of transducers soldered.

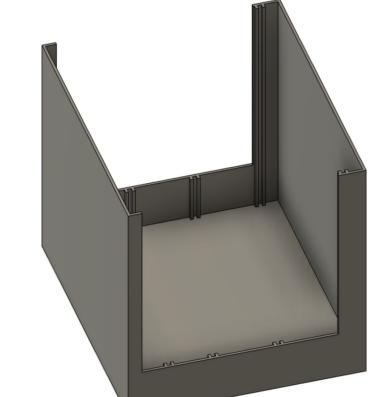


Fig 4. New 3D printed box for all the SBCs and PCBs except PAA board.

# Software Controls and Sound Generation

- Pampin and McCrea's prototype already had software for generating the modulated signals.
- We integrated it with a python script to enable remote control.
- A single board computer (SBC) runs the sound generation software and python script.
- The SBC is connected to an android app over bluetooth • We created a JSON API to communicate between the app and the SBC.
- The app can:
  - Scan for wifi networks and connect to them
  - Play and pause sound output

- replacement.

- Use universal plug-in connector on AMP and PAA boards.
- Test different parametric acoustic arrays with different layouts and transducers.
- Polish the android app and add more remote control features.
- Add sound file playback and input selection to the SBC.
- Integration with advanced technologies such as sensing systems to allow automatic steering.

# Acknowledgements and References

- Thank you to the Chameleon Capstone Team for loaning us an MCHstreamer Lite to use during our product development!
- Thank you to Katherine and SQRLab for loaning us the soldering heat gun.

7, p. 2148, Apr. 2020, doi: https://doi.org/10.3390/s20072148. Adelaide, Australia, Sep. 2004.

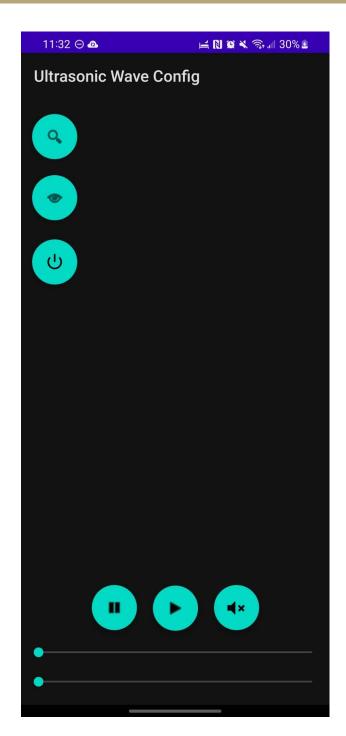


Fig 5. The app user interface

# Results

• We successfully minitrarized the size and weight of the whole device. The box containing the SBCs and PCBs has a size of only one eighth of the prototype rack. • The new transducer requires lower voltage and the PAA board is thinner because the new transducer is surface-mount. However it performs too poorly to be a suitable

• Although more testing would be needed to evaluate the performance of the whole device, we've paved the way for future development and optimization.

# **Future Work**

- [1] H. Zhou, S. H. Huang, and W. Li, "Parametric Acoustic Array and Its Application in Underwater Acoustic Engineering," Sensors, vol. 20, no.
- [2] C. Howard, C. Hansen, and A. Zander, "A Review of Current Ultrasound Exposure Limits," School of Mechanical Engineering, University of